

# RFM News Release

Contacts: RF Monolithics, Inc  
Investor Relations  
Carol Bivings  
972-448-3767

Tai-Saw Technology  
General Manager  
Allen C.H. Wu  
886-3-4690038

## **RF Monolithics, Inc. Announces Offshore Foundry Partner**

**Dallas, Texas (January 8, 2002) RF Monolithics, Inc. (RFM) (Nasdaq: RFMI)** today announced it had signed a manufacturing agreement with Tai-Saw Technology Co., Ltd (TST), to provide wafer fabrication for its SAW based products. TST's operations, which include wafer fabrication, assembly, test, screening and support operations, are located in Taoyuan, Taiwan.

David Kirk, President and CEO of RFM, stated, "TST is the fourth offshore business alliance we have developed since implementing our strategic plan to transition our assembly offshore. TST is, however, our first partner to provide a second source wafer fabrication foundry. In addition to providing additional wafer fabrication to address surges in customer demands, we believe our alliance with TST also gives us the opportunity to expand our current technical capabilities and enhance our supply chain. We are very excited about the possibilities this relationship brings to both parties."

Yu-Tung Huang, President of TST, commented, "We are also pleased with the opportunities offered by this alliance. We feel our superior engineering resources and great supporting infrastructure in northern Taiwan make us an ideal partner for RFM. We believe in addition to providing RFM quality foundry and assembly services we also offer a broad range of technical experience which will allow us to contribute and participate in RFM's future growth plans."

### **About RFM**

RFM, headquartered in Dallas, Texas, is a leading developer, manufacturer and supplier of a broad range of radio frequency components, and modules based on surface acoustic wave technology for the automotive, telecommunication, industrial, consumer and distribution markets worldwide.

### **About TST**

TST, was founded in 1997 by engineers formerly with Motorola with a goal to become the leading manufacturing service provider for high performance communications components and to advance processing technology for the application of wide band-gap piezoelectric wafers. TST's services include wafer fabrication, assembly, screening and testing, and technical support.

-More-

*This news release contains forward-looking statements within the meaning of Section 21E of the Securities Exchange Act of 1934, as amended. Although the Company believes that in making any such statement that its expectations are based upon reasonable assumptions, any such statement involves substantial risks and uncertainties including, but not limited to, those detailed from time to time in the Company's SEC reports, including the report on Form 10-K for the year ended August 31, 2001. Such risks and uncertainties could cause the actual outcomes of matters addressed in its forward-looking statements to vary materially from those set forth herein. The Company does not assume any obligation to update any forward-looking information contained in this release.*

*– End-*